

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul Robert Hoffman and David Albert Zoba

Assignee: Amkor Technology, Inc.

Title: Structures For Improving Heat Dissipation In
Stacked Semiconductor Packages

Serial No.: 10/771,072 File Date: 02/02/2004

Examiner: Not Yet Assigned Art Unit: 2812

Docket No.: AMK-11317-1D

Date: May 4, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REQUEST TO CHANGE INVENTORSHIP PURSUANT TO 37 CFR 1.48(b) AND
AUTHORIZATION OF THE REQUIRED FEE UNDER 37 CFR 1.17(i)

Dear Sir:

Please delete Paul Robert Hoffman as an inventor of the present application. Due to cancellation of certain of the claims, the invention of Paul Robert Hoffman is no longer being claimed in the application.

The undersigned is an attorney of record.

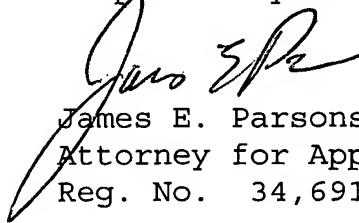
Please charge Deposit Acct. 50-0574 the amount of \$130.00 for this request. If any additional extension and/or fee is required, also charge Account No. 50-0574.

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If there are any questions, please telephone the
undersigned at 408 451-5906.

Respectfully submitted,

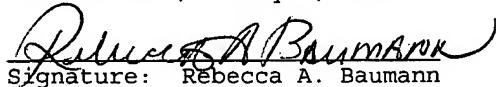


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I hereby certify that this correspondence is being deposited
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5/4/2004
Date



Rebecca A. Baumann
Signature: Rebecca A. Baumann